## Features

- Access to Summing Node Allows Circuit Customization
- User Programmable For Closed-Loop Gains of +1, -1 or +2 Without Use of External Resistors
- Wide -3dB Bandwidth . . . . . . . . . . . . . . . . . . . . 850 MHz
- Very Fast Slew Rate $\qquad$ 2400V/ $\mu \mathrm{s}$
- Fast Settling Time (0.1\%) .11ns
- High Output Current . . . . . . . . . . . . . . . . . . . . . . . 60mA
- Excellent Gain Accuracy. . . . . . . . . . . . . . . . . . 0.99V/V
- Overdrive Recovery. . . . . . . . . . . . . . . . . . . . . $<$ <10ns
- Standard Operational Amplifier Pinout


## Applications

- RF/IF Processors
- Driving Flash A/D Converters
- High Speed Communications
- Impedance Transformation
- Line Driving
- Video Switching and Routing
- Radar Systems
- Medical Imaging Systems


## Description

The HFA1114 is a closed loop Buffer featuring user programmable gain and ultra high speed performance. Manufactured on Intersil' proprietary complementary bipolar UHF-1 process, the HFA1114 offers a wide -3dB bandwidth of 850 MHz , very fast slew rate, excellent gain flatness, low distortion and high output current.

A unique feature of the pinout allows the user to select a voltage gain of $+1,-1$, or +2 , without the use of any external components. Gain selection is accomplished via connections to the inputs, as described in the "Application Information" section. The result is a more flexible product, fewer part types in inventory, and more efficient use of board space.
Compatibility with existing op amp pinouts provides flexibility to upgrade low gain amplifiers, while decreasing component count. Unlike most buffers, the standard pinout provides an upgrade path should a higher closed loop gain be needed at a future date.

For applications requiring a standard buffer pinout, please refer to the HFA1110 datasheet.

## Ordering Information

| PART NUMBER <br> (BRAND) | TEMP. RANGE <br> ( $\left.{ }^{\circ} \mathrm{C}\right)$ | PACKAGE | PKG. <br> NO. |
| :--- | :---: | :--- | :---: |
| HFA1114IB <br> (H1114I) | -40 to 85 | 8 Ld SOIC | M8.15 |
| HFA11XXEVAL | DIP Evaluation Board for High Speed <br> Op Amps |  |  |

## Pinout



## Pin Descriptions

| NAME | PIN <br> NUMBER | DESCRIPTION |
| :---: | :---: | :--- |
| NC | 1,8 | No Connection |
| - IN | 2 | Inverting Input |
| + IN | 3 | Non-Inverting Input |
| V- | 4 | Negative Supply |
| SN | 5 | Summing Node |
| OUT | 6 | Output |
| V+ | 7 | Positive Supply |

Absolute Maximum Ratings
Voltage Between V+ and V- . . . . . . . . . . . . . . . . . . . . . . . . . . . . 12V
DC Input Voltage .......................................... . . VSUPPLY
Differential Input Voltage . ......................................... . . 5 V
Output Current . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 60mA

## Operating Conditions

## Thermal Information

| Thermal Resistance (Typical, Note 1) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| SOIC Package. | 170 |
| Maximum Junction Temperature (Die). | $175{ }^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature (Plastic Package) | $150^{\circ} \mathrm{C}$ |
| Maximum Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Maximum Lead Temperature (Soldering 10s) | $300^{\circ}$ |

Temperature Range
$-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. $\theta_{\mathrm{JA}}$ is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, A_{V}=+1, R_{L}=100 \Omega$, Unless Otherwise Specified

| PARAMETER | TEST CONDITIONS | TEMP. $\left({ }^{\circ} \mathrm{C}\right)$ | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Output Offset Voltage |  | 25 | - | 8 | 25 | mV |
|  |  | Full | - | - | 35 | mV |
| Output Offset Voltage Drift |  | Full | - | 10 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| PSRR |  | 25 | 39 | 45 | - | dB |
|  |  | Full | 35 | - | - | dB |
| Input Noise Voltage | 100 kHz | 25 | - | 9 | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Non-Inverting Input Noise Current | 100kHz | 25 | - | 37 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Non-Inverting Input Bias Current |  | 25 | - | 25 | 40 | $\mu \mathrm{A}$ |
|  |  | Full | - | - | 65 | $\mu \mathrm{A}$ |
| Non-Inverting Input Resistance |  | 25 | 25 | 50 | - | $\mathrm{k} \Omega$ |
| Inverting Input Resistance |  | 25 | 240 | 300 | 360 | $\Omega$ |
| Input Capacitance | Either Input | 25 | - | 2 | - | pF |
| Input Common Mode Range |  | Full | $\pm 2.5$ | $\pm 2.8$ | - | V |

TRANSFER CHARACTERISTICS

| Gain | $A_{V}=+1, V_{\text {IN }}=+2 \mathrm{~V}$ | 25 | 0.980 | 0.990 | 1.02 | V/V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Full | 0.975 | - | 1.025 | V/V |
|  | $A_{V}=+2, V_{1 N}=+1 \mathrm{~V}$ | 25 | 1.96 | 1.98 | 2.04 | V/V |
|  |  | Full | 1.95 | - | 2.05 | V/V |
| DC Non-Linearity | $A_{V}=+2, \pm 2 \mathrm{~V}$ Full Scale | 25 | - | 0.02 | - | \% |

OUTPUT CHARACTERISTICS

| Output Voltage | $\mathrm{A}_{\mathrm{V}}=-1$ | 25 | $\pm 3.0$ | $\pm 3.3$ | - | V |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  | Full | $\pm 2.5$ | $\pm 3.0$ | - | V |
| Output Current | $\mathrm{A}_{\mathrm{V}}=-1, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | 25,85 | 50 | 60 | - | mA |
|  |  | $-40^{\circ} \mathrm{C}$ | 35 | 50 | - | mA |
| Closed Loop Output Impedance | $\mathrm{A}_{\mathrm{V}}=+2, \mathrm{DC}$ | 25 | - | 0.3 | - | $\Omega$ |

Electrical Specifications $V_{\text {SUPPLY }}= \pm 5 \mathrm{~V}, A_{V}=+1, R_{L}=100 \Omega$, Unless Otherwise Specified (Continued)

| PARAMETER | TEST CONDITIONS | TEMP. $\left({ }^{\circ} \mathrm{C}\right)$ | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Supply Voltage Range |  | Full | $\pm 4.5$ | - | $\pm 5.5$ | V |
| Supply Current |  | 25 | - | 21 | 26 | mA |
|  |  | Full | - | - | 33 | mA |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| -3 dB Bandwidth ( $\left.\mathrm{V}_{\mathrm{OUT}}=0.2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}\right)$ | $A_{V}=-1$ | 25 | - | 800 | - | MHz |
|  | $A_{V}=+1$ | 25 | - | 850 | - | MHz |
|  | $A_{V}=+2$ | 25 | - | 550 | - | MHz |
| Slew Rate ( $\left.\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}_{\text {P-P }}\right)$ | $A_{V}=-1$ | 25 | - | 2400 | - | V/us |
|  | $A_{V}=+1$ | 25 | - | 1500 | - | V/us |
|  | $A_{V}=+2$ | 25 | - | 1900 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Full Power BW | $5 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}, \mathrm{A}_{\mathrm{V}}=+2$ | 25 | - | 220 | - | MHz |
| Gain Flatness | To $30 \mathrm{MHz}, \mathrm{AV}_{\mathrm{V}}=+2$ | 25 | - | $\pm 0.015$ | - | dB |
| Gain Flatness | To $100 \mathrm{MHz}, \mathrm{AV}^{\prime}=+2$ | 25 | - | $\pm 0.07$ | - | dB |
| 2nd Harmonic Distortion | $50 \mathrm{MHz}, \mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {P-P }}$ | 25 | - | -53 | - | dBc |
| 3rd Harmonic Distortion | $50 \mathrm{MHz}, \mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ | 25 | - | -68 | - | dBc |
| 3rd Order Intercept | $100 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+2$ | 25 | - | 28 | - | dBm |
| 1 dB Compression | $100 \mathrm{MHz}, \mathrm{AV}_{\mathrm{V}}=+2$ | 25 | - | 19 | - | dBm |
| Rise Time (VOUT $=0.5 \mathrm{~V}$ Step) | $A_{V}=+2$ | 25 | - | 700 | - | ps |
|  | $A_{V}=+1$ | 25 | - | 480 | - | ps |
| Overshoot | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}$ Step, $\mathrm{A}_{\mathrm{V}}=+2$ | 25 | - | 6 | - | \% |
| 0.1\% Settling Time | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ to 0 V | 25 | - | 11 | - | ns |
| 0.05\% Settling Time | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ to 0 V | 25 | - | 15 | - | ns |
| Overdrive Recovery Time |  | 25 | - | 8.5 | - | ns |
| Differential Gain | $\mathrm{A}_{\mathrm{V}}=+1,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.03 | - | \% |
|  | $A_{V}=+2,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.02 | - | \% |
| Differential Phase | $A_{V}=+1,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.05 | - | Degrees |
|  | $\mathrm{A}_{\mathrm{V}}=+2,3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega$ | 25 | - | 0.04 | - | Degrees |

## Application Information

## Closed Loop Gain Selection

The HFA1114 features a novel design which allows the user to select from three closed loop gains, without any external components. The result is a more flexible product, fewer part types in inventory, and more efficient use of board space.
This "buffer" operates in closed loop gains of $-1,+1$, or +2 , and gain selection is accomplished via connections to the $\pm$ inputs. Applying the input signal to +IN and floating -IN selects a gain of +1 , while grounding -IN selects a gain of +2 . A gain of -1 is obtained by applying the input signal to -IN with +IN grounded.
The table below summarizes these connections:

| GAIN | CONNECTIONS |  |
| :---: | :---: | :---: |
|  | +INPUT (PIN 3) | -INPUT (PIN 2) |
| -1 | GND | Input |
| +1 | Input | NC (Floating) |
| +2 | Input | GND |

## PC Board Layout

The frequency response of this amplifier depends greatly on the amount of care taken in designing the PC board. The use of low inductance components such as chip resistors and chip capacitors is strongly recommended, while a solid ground plane is a must!
Attention should be given to decoupling the power supplies. A large value $(10 \mu \mathrm{~F})$ tantalum in parallel with a small value $(0.1 \mu \mathrm{~F})$ chip capacitor works well in most cases.
Terminated microstrip signal lines are recommended at the input and output of the device. Capacitance directly on the output must be minimized, or isolated as discussed in the next section.
For unity gain applications, care must also be taken to minimize the capacitance to ground seen by the amplifier's inverting input. At higher frequencies this capacitance will tend to short the -INPUT to GND, resulting in a closed loop gain which increases with frequency. This will cause excessive high frequency peaking and potentially other problems as well.
An example of a good high frequency layout is the Evaluation Board shown in Figure 2.

## Driving Capacitive Loads

Capacitive loads, such as an $A / D$ input, or an improperly terminated transmission line will degrade the amplifier's phase margin resulting in frequency response peaking and possible oscillations. In most cases, the oscillation can be avoided by placing a resistor $\left(R_{S}\right)$ in series with the output prior to the capacitance.


Figure 1 details starting points for the selection of this resistor. The points on the curve indicate the $R_{S}$ and $C_{L}$ combinations for the optimum bandwidth, stability, and settling time, but experimental fine tuning is recommended. Picking a point above or to the right of the curve yields an overdamped response, while points below or left of the curve indicate areas of underdamped performance.
$R_{S}$ and $C_{L}$ form a low pass network at the output, thus limiting system bandwidth well below the amplifier bandwidth of 850 MHz . By decreasing $\mathrm{R}_{\mathrm{S}}$ as $\mathrm{C}_{\mathrm{L}}$ increases (as illustrated in the curves), the maximum bandwidth is obtained without sacrificing stability. Even so, bandwidth does decrease as you move to the right along the curve. For example, at $A_{V}=+1, R_{S}=50 \Omega, C_{L}=30 \mathrm{pF}$, the overall bandwidth is limited to 300 MHz , and bandwidth drops to 100 MHz at $A_{V}=+1, R_{S}=5 \Omega, C_{L}=340 \mathrm{pF}$.


FIGURE 1. RECOMMENDED SERIES OUTPUT RESISTOR vs LOAD CAPACITANCE

## Evaluation Board

The performance of the HFA1114 may be evaluated using the HFA11XX Evaluation Board, slightly modified as follows:
2. Remove the $500 \Omega$ feedback resistor $\left(R_{2}\right)$, and leave the connection open.
3. a. For $A_{V}=+1$ evaluation, remove the $500 \Omega$ gain setting resistor $\left(R_{1}\right)$, and leave pin 2 floating.
b. For $A_{V}=+2$, replace the $500 \Omega$ gain setting resistor with a $0 \Omega$ resistor to GND.
4. Isolate Pin 5 from the stray board capacitance to minimize peaking and overshoot.
The layout and modified schematic of the board are shown in Figure 2.
To order evaluation boards (part number HFA11XXEVAL), please contact your local sales office.
Note: The SOIC version may be evaluated in the DIP board by using a SOIC-to-DIP adapter such as Aries Electronics Part Number 08-350000-10.


FIGURE 2. EVALUATION BOARD SCHEMATIC AND LAYOUT

## Die Characteristics

DIE DIMENSIONS:
63 mils $\times 44$ mils $\times 19$ mils
$1600 \mu \mathrm{~m} \times 1130 \mu \mathrm{~m} \times 483 \mu \mathrm{~m}$
METALLIZATION:
Type: Metal 1: AICu(2\%)/TiW
Thickness: Metal 1: $8 \mathrm{k} \AA \pm 0.4 \mathrm{k} \AA$
Type: Metal 2: AICu(2\%)
Thickness: Metal 2: $16 \mathrm{k} \AA \not \pm 0.8 \mathrm{k} \AA$

## PASSIVATION:

Type: Nitride
Thickness: $4 \mathrm{k} \AA \pm 0.5 \mathrm{k} \AA$
TRANSISTOR COUNT:
52
SUBSTRATE POTENTIAL (Powered Up):
Floating (Recommend Connection to V-)

## Metallization Mask Layout

HFA1114


All Intersil semiconductor products are manufactured, assembled and tested under ISO9000 quality systems certification.
Intersil products are sold by description only. Intersil Corporation reserves the right to make changes in circuit design and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see web site http://www.intersil.com

